

SEMISTACK - SKAI



SKAI Solutions

600V IGBT Advanced Drive System

SKAI 4001GD06 1452 W

SemiKron Advanced Integration (SKAI) module
Liquid-cooled version

Preliminary Data

Features

- New generation 600V NPT IGBT on AIN DCB substrate.
- Integrated DC-link film capacitor
- Pressure contact technology for improved power cycling performance
- Optimal thermal management with integrated liquid-cooled heatsink
- Two integrated current sensors with option to include three
- Integrated gate drive and power supply with under-voltage protection. 25-pin DB connector is standard on driver only versions
- Option to include an integrated controller based on TMS320LF2407ADSP. 14-pin AMP SEAL connector is standard on controller versions.

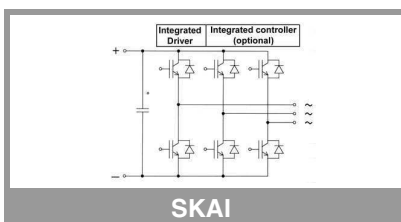
Typical Applications

- Vehicles
- Hybrid vehicles
- Motor Drives
- Regenerative Drives

¹⁾ Contact SEMIKRON for power loss calculations

²⁾ "s" referenced to built-in Temp. Sensor

³⁾ 50% Water, 50% Glycol



Circuit	I _{rms}	V _{dc}	Types
B6CI	400	450	SKAI 4001GD06 1452 W

Symbol	Conditions	Values	Units
I _{rms} ¹⁾	no overload, T _{coolant} = 50°C, 10kHz, p.f.=0,8 overload, t<20s	400 500 600	A A V
V _{CES}			
V _{CEO}	IGBT T _j = 125°C	1	V
r _{CE}	T _j = 125°C	2,75	mΩ
V _{CEsat}	400A, T _j = 25 / 125 °C	1,9 / 2,1	V
E _{ON} + E _{OFF}	V _{CC} = 300/400V, I _c = 400A, T _j = 125°C	27 / 38	mJ
V _{TO}	Inverse diode T _j = 125°C	0,81	V
r _T	T _j = 125°C	1,65	mΩ
V _F =V _{EC}	400A, T _j = 25 / 125 °C	1,46 / 1,47	V
E _{ON} + E _{OFF}	V _{CC} = 300/400V, I _c = 400A, T _j = 125°C	10 / 13,0	mJ
R _{thjs} ²⁾	Thermal Characteristics / Heatsink per IGBT	0,065	K/W
R _{thjs} ²⁾	per diode	0,13	K/W
R _{thsa} ²⁾	Heatsink to coolant ³⁾ , flow rate V _f = 15 l/min	9,3	K/kW
	Heatsink to coolant ³⁾ , flow rate V _f = 5 l/min	13,4	K/kW
P _{aDR}	Pressure drop, Coolant flow rate V _f = 5 l/min	0,05	bar
	Pressure drop, Coolant flow rate V _f = 15 l/min	0,55	bar
C _{eqvl}	Capacitor bank total equivalent capacitance	1	mF
V _{DCmax}	max. DC voltage applied to capacitor bank	450	V
V _s	Driver Power supply: typ value	24	V
	Power supply: min / max values	8 / 30	V
I _s	Supply current	500	mA
dV/dt	Primary to Secondary Side	15	kV/μs
f _{SWmax}	Max. Switching Frequency	20	kHz
V _{isol}	power terminals to heatsink and signal connector: AC, 1 min.	2500	V
T _{vj}	Junction temperature (not including driver)	-40...+150	°C
T _{stg}	Storage Temperature	-40...+125	°C
T _{amb}	Operating ambient temperature	-40...+85	°C
I _{TRIPSC}	Protection Short Circuit Protection	1000	A
T _{TRIP}	Over-Temp. Protection	115	°C
U _{DCTRIP}	V _{CC} Overvoltage Protection	458	V
L x W x H	Dimensions Length x Width x Height	400 x 215 x 100	mm
w	approx.	8,2	kg

